

Form <b>PTO-1595</b>	102751878	JHEET  U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office		
Rev. 03/ 01)  DMB No. 0651-0027 (exp. 5/31/2002)  PATENTS ONLY				
To the Honorable Commissioner of Pate	ents and Trademarks: Pl	lease record the attached original documents or copy thereof		
Name of conveying party(ies):     Wakaba Sakai	5.19.84	2. Name and address of receiving party(ies)  Name: Sony Corporation  Internal Address:		
Additional name(s) of conveying party(ies) attached?  3. Nature of Conveyance:  X Assignment	Yes X No	Street Address: 6-7-35 Kitashinagawa Shinagawa-Ku,		
	hange of Name	City: Tokyo  State: JAPAN Zip: 141-0001  Additional name(s) & Yes X No address(es) attached:		
4. Application number(s) or patent not seem of the second	07	B. Patent No.(s):		
Name and address of party to whom concerning document should be ma	correspondence	6. Total number of applications and patents involved:		
Name: RADER, FISHMAN & GRAUER PLLC		7. Total fee (37 CFR 3.41) \$40.00		
Internal Address: Atty. Dkt.: SDE-15 Street Address: 1233 20th Street, N.W. Suite 501	570	Enclosed  X Authorized to be charged to deposit account Authorized to be charged to credit card (Form 2038 enclosed)		
City: State: Washington DC	Zip: 20036	Deposit account number:		
	DO NOT USE	THIS SPACE		
9. Statement and signature.  To the best of my knowledge and be is a true copy of the original docume.  Shawn B. Cage  Name of Person Signing  Total number of pages inc	nt.	May 19, 2004 Signature Date		

05/24/2004 GTUN11 00000041 180013 29205632 01 FC:8021 40.00 BA

> PATENT REEL: 015352 FRAME: 0251

Docket Number: SDE-1570

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

## COMBINED HEADPHONE AND AUDIO PLAYER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 6-7-35 Kitashinagawa, Shinagawa-ku, Tokyo, JAPAN, (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

PATENT REEL: 015352 FRAME: 0252 And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number:

RECORDED: 05/19/2004

, Filing Date:

This assignment executed on the dates indicated below.

Wakaba SAKAI	wakaba Lakai	April 7. 2009
	Signature	Date

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